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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

363
897

APPL NUM 10042271	FILING DATE 01/11/2002	CLASS 451	SUBCLASS 41	GAU 3723	EXAMINER MCDONALD D. NGUYEN
**APPLICANTS: Yoshida Masato; Ashizawa Toranosuke; Terazaki Hiroki; Ootuki Yuuto; Kurata Yasushi; Matsuzawa Jun; Tanno Kiyohito;					
**CONTINUING DATA VERIFIED: THIS APPLICATION IS A CON OF 09/581,814 09/08/2000 PAT 6,343,976 * (*) Data inconsistent with PTO records.					
** FOREIGN APPLICATIONS VERIFIED: JAPAN 09-349240 12/18/1997 JAPAN 10-083042 03/30/1998 JAPAN 10-083043 03/30/1998					
PG-PUB		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>	
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials				ATTORNEY DOCKET NO 566.38683CX1	
TITLE : Abrasive, method of polishing target member and process for producing semiconductor device <small>U.S. DEPT. OF COMM / PAT. & TM. PTO-435L (Rev. 12-94)</small>					

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Assistant Examiner Primary Examiner	
ISSUE FEE		Total Claims Print Claim for O.G.	
Amount Due	Date Paid	DRAWING Sheets Drwg. Figs. Drwg. Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner PREPARED FOR ISSUE WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.	

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